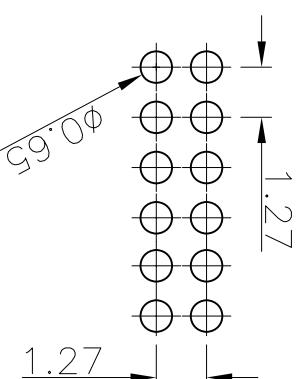


Recommended P.C.Board
Hole Layout
(Tolerance:±0.05)



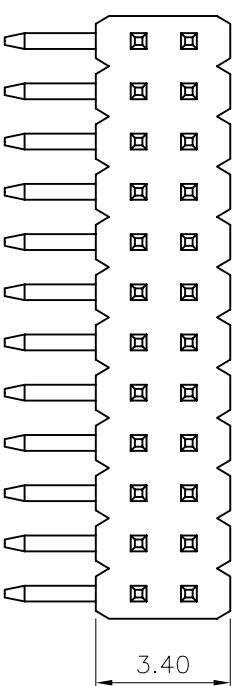
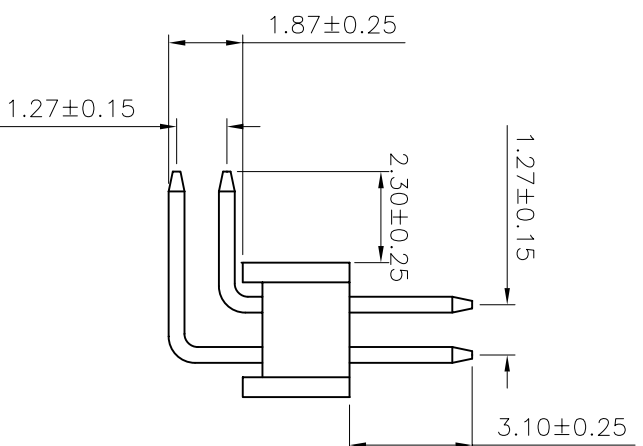
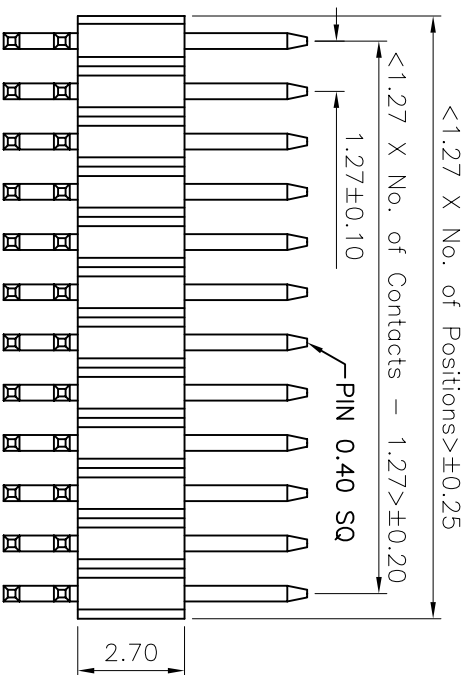
REV.	LOCALS	DESCRIPTION	DATE	DRAWN
02	△	變更塑膠材質	07.11.23	周禮軍
03	△	變更料號	2008.08.29	彭思城
04	△	變更圖號並修改注解	2011.03.16	黃明霞

Specifications
 Current Rating:1Amp
 Insulation Resistance:1000MΩMin.
 Dielectric Withstanding: 300VAC
 Contact Resistance:20mΩMax.
 Operating Temperature:-40°C to +105°C
 Materials
 Contact Material: Brass
 Insulator Material: High Temperature
 Thermoplastic, UL 94V-0 LCP△
 or the equivalent material
 All materials must meet Greenconn
 requirement for environment protection.

Ordering Information △

G PEB213-XX XX A018 C 1 B X

No. of Pins per Row Standard Plating Standard Packing
 02~40 02=Gold Flash C=Tube
 Selective Plating Selective Packing
 01=Tin A=box
 05=Gold Flash/Tin



REV. 04	UNIT. mm	SCALE. 1:1	PAGE. 1/1	GENERAL TOLERANCE
				X:±5.0°
				.X:±3.0°
				.XX:±2.0°
				.XXX:±1.0°

DESIGN: 黃明霞	DATE: 2011.03.16
CHECKED: 李新華	DATE: 2011.03.16
AUDITED: Lear	DATE: 2011.03.16

DWG. NO. △△	TITLE.
GPEB213-CA18CB	1.27 PIN HEADER
PART NO. △	DUAL ROWS R/A TYPE
GPEB213-XXXXA018C1BX	BASE 2.70H

格菱股份有限公司
Greenconn Corporation

